



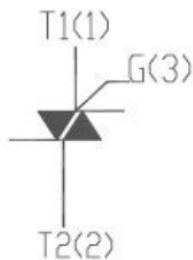
BT138

12 A standard and Snubberless™ triacs



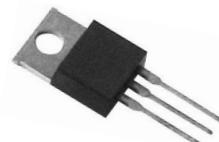
Features

- High current triac
- Low thermal resistance with clip bonding
- High commutation (4 quadrant) or very high commutation (3 quadrant) capability



VOLTAGE RANGE 600/800 Volts

CURRENT 12 Ampere



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
VDRM VRM	Repetitive Peak Off-State Voltage	BT138-600	600	V
		BT138-800	800	V
IT(RMS)	R.M.S On-State Current	T _c =110°C	12	A
ITSM	Surge On-State Current	t _p =16.7ms/t _p =10ms	115/120	A
I ² t	I ² t for fusing	T _p =10ms	70	A ² s
PG(AV)	Average Gate Power Dissipation	T _j =125°C	1	W
IGM	Peak Gate Current	t _p =20us T _j =125°C	4	A
T _j	Operating Junction Temperature		~40~125	°C
TSTG	Storage Temperature		~40~150	°C

BT138

Electrical Characteristics (T_j=25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Value				Unit	
			D	E	F	G		
IDRM	Repetitive Peak Off-State Current	T _j =25°C			≤5		uA	
		T _j =125°C			≤1		mA	
IRRM	Repetitive Peak Reverse Current	T _j =25°C			≤5		uA	
		T _j =125°C			≤1		mA	
VTM	Forward "on" voltage	I _T =35A t _p =380us			≤1.55		V	
VGT	Gate trigger voltage	V _D =12V ,R _L =30Ω			≤1.5		V	
di/dt	Critical-rate of rise of commutation current.	I,II,III	T _j =125°C ,I _G =2XIGT,tr ≤100ns,F=100Hz		≥50		A /μs	
		IV			≥10		A /μs	
IGT	Gate trigger current	I,II,III	V _D =12V R _L =30Ω	≤5	≤10	≤25	≤50	mA
		IV		≤10	≤25	≤70	≤100	mA
IH	Holding current	I _T =0.2A		≤10	≤25	≤30	≤60	mA
VGD	Gate non-trigger voltage	ALL	V _D =V _{DRM} T _J =125°C,R _L =3.3KΩ			≥0.2		V
dv/dt	Critical-rate of rise of commutation voltage		T _J =125°C V _D =2/3V _{DRM} Gate	≥5	≥10	≥50	≥200	V/μs

BT138W(3 quadrants)

di/dt	Critical-rate of rise of commutation current.	I,II,III	T _j =125°C ,I _G =2XIGT,tr ≤100ns,F=100Hz		≥50			A /μs
IGT	Gate trigger current	I,II,III	V _D =12V R _L =30Ω	D	E	F	G	mA
				≤5	≤10	≤25	≤50	

RATING AND CHARACTERISTIC CURVES (BT138)

FIG.6: Maximum power dissipation versus RMS on-state current

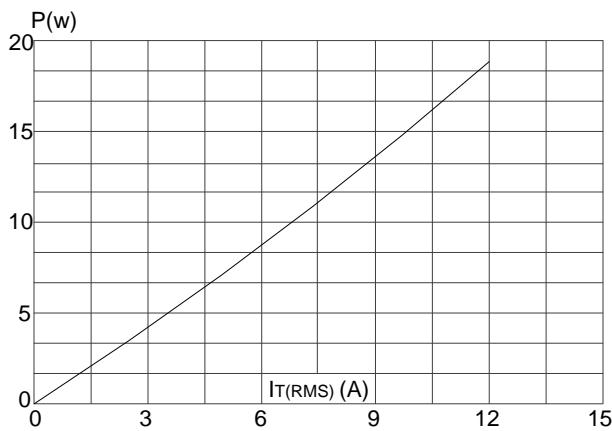


FIG.6: Surge peak on-state current versus number of cycles

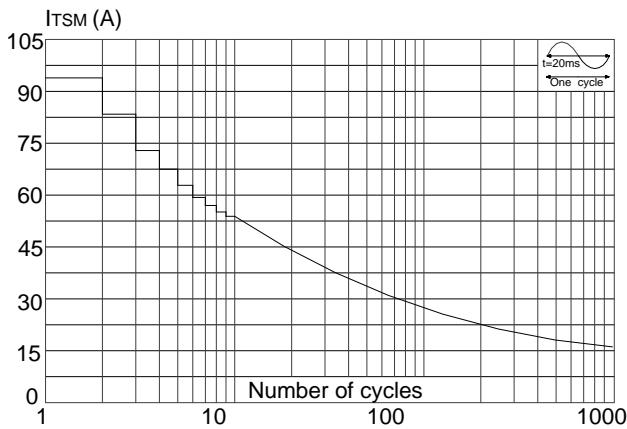


FIG.6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $tp < 20\text{ms}$, and corresponding value of I^2t ($dl/dt < 100\text{A}/\mu\text{s}$)

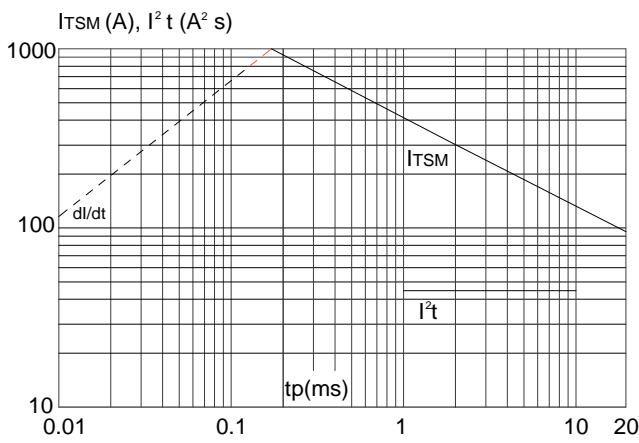


FIG.6: RMS on-state current versus case temperature

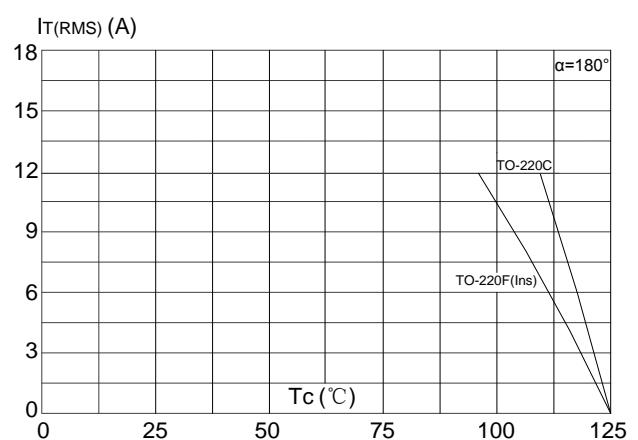


FIG.6: On-state characteristics (maximum values)

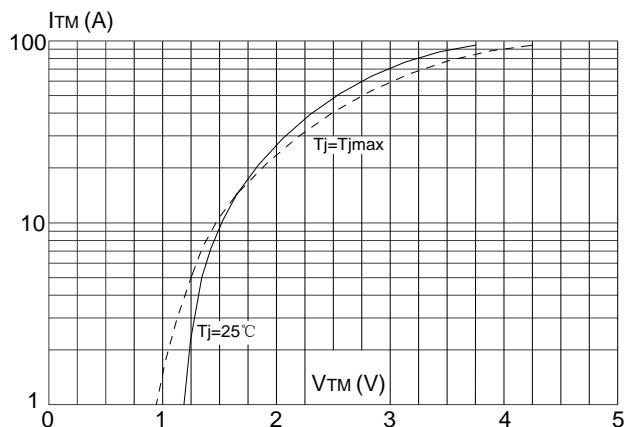
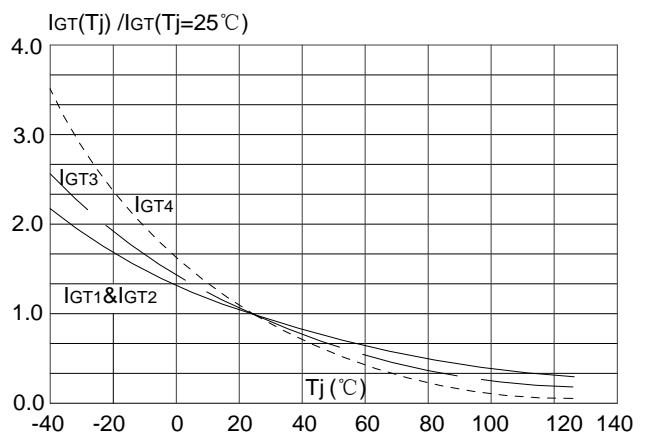


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



RATING AND CHARACTERISTIC CURVES (BT138)

FIG.7: Relative variations of holding current versus junction temperature

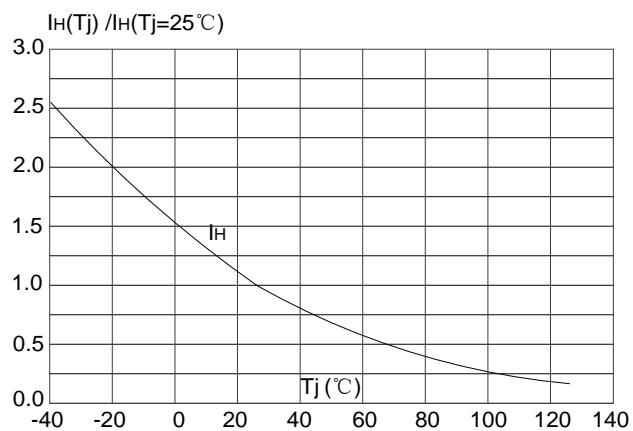
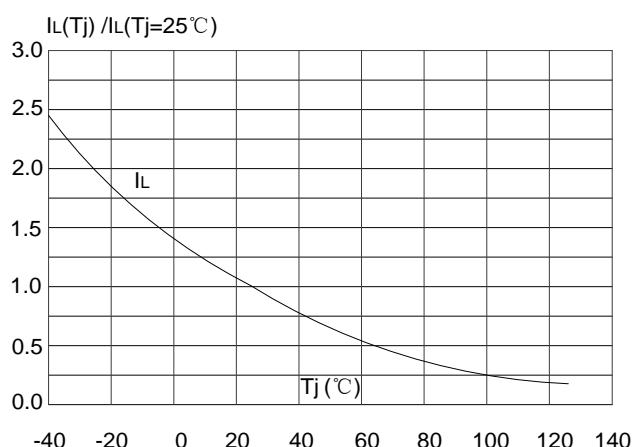
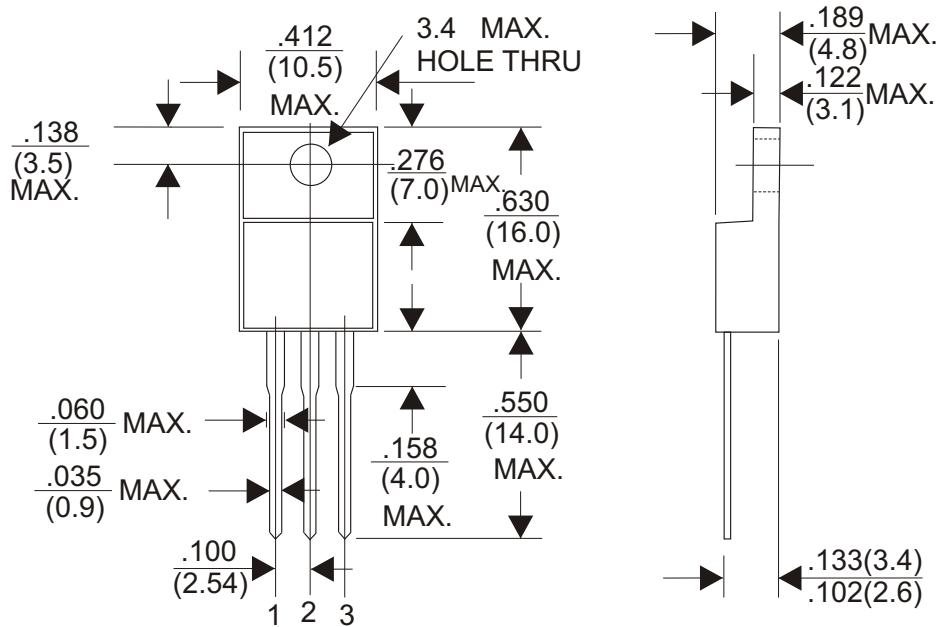


FIG.8: Relative variations of latching current versus junction temperature



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